Declaration, Power of Attorney and Petition

WE (I) the undersigned inventor(s), hereby declare(s) that:

the specification of which

My residence, post office address and citizenship are as stated below next to my name,

We (I) believe that we are (I am) the original, first and joint (sole) inventor(s) of the subject matter which is claimed and for which a patent is sought on the invention entitled

SILICON CARBIDE MATRIX COMPOSITE MATERIAL, PROCESS FOR PRODUCING THE SAME AND PROCESS FOR PRODUCING PART OF SILICON CARBIDE MATRIX COMPOSITE MATERIAL

☑ is attache	ed hereto.	
☐ was filed	l on	as
Applicat	ion Serial No.	
and ame	nded on	
⊠ was filed	was filed as PCT international application	
Number	PCT/JP03/07700	
on June	18, 2003	

and was amended under PCT Article 19

We (I) hereby state that we (I) have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.

(if applicable).

- We (I) acknowledge the duty to disclose information known to be material to the patentability of this application as defined in Section 1.56 of Title 37 Code of Federal Regulations.
- We (I) hereby claim foreign priority benefits under 35 U.S.C. §119(a)-(d) or §365(b) of any foreign application(s) for patent or inventor's certificate, or §365(a) of any PCT International application which designated at least one country other than the United States, listed below and have also identified below, by checking the box, any foreign application for patent or inventor's certificate, or PCT International application having a filing date before that of the application on which priority is claimed. Prior Foreign Application(s)

Application No.	Country	Day/Month/Year	Priority Claimed
P2002-176680	Japan	18/June/2002	⊠ Yes □ No
P2002-190588	Japan	28/June/2002	⊠ Yes □ No
P2003-188954	Japan	30/June/2003	☐ Yes 🛭 No

(Application Number) (Application Number)		(Filing	Date)
		(Filing	Date)
PCT International application the claims of this application provided by the first paragra	on designating the United S n is not disclosed in the pri aph of 35 U.S.C. §112, I ac 37 CFR §1.56 which becan	States, listed below and or United States or PCI knowledge the duty to ne available between th	s application(s), or under §365(c) of any insofar as the subject matter of each of International application in the manner disclose information which is material to e filing date of the prior application and
Application Serial No.	. Filin	ng Date	Status (pending, patented, abandoned)
ousiness in the Patent Offic	full powers of substitution	omer Number 22850 and revocation, to prosed we (I) hereby reques	ecute this application and to transact all t that all correspondence regarding this
we (I) declare that all on information and belief a willful false statements and little 18 of the United States	full powers of substitution ce connected therewith; and custo statements made herein of the believed to be true; and it the like so made are punits a Code and that such willful	and revocation, to prosect we (I) hereby request the Number 2850 our (my) own knowled further that these statements in the statements of the statement of the statements of the statement of the statements of th	t that all correspondence regarding this ge are true and that all statements made ents were made with the knowledge that
We (I) declare that all on information and belief and willful false statements and citle 18 of the United States or any patent issuing thereof Shoko SUYAMA	full powers of substitution ce connected therewith; and custo statements made herein of the believed to be true; and for the like so made are punits as Code and that such willfurn.	and revocation, to prosent we (I) hereby request the end we (I) hereby request the end of the end o	ge are true and that all statements made ents were made with the knowledge that sonment, or both, under Section 1001 of
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We (I) declare that all on information and belief an willful false statements and citle 18 of the United States or any patent issuing thereof Shoko SUYAMA	full powers of substitution ce connected therewith; and custom statements made herein of the believed to be true; and in the like so made are punits as Code and that such willfurn. LE INVENTOR	and revocation, to prosend we (I) hereby request the revocation of the revocation, to prosend we (I) hereby request the revocation of the revocation, to prosent output the revocation of the revocati	ge are true and that all statements made ents were made with the knowledge that sonment, or both, under Section 1001 of eopardize the validity of the application awasaki-shi, Kanagawa-ken, Japan

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